SP	ECIFICATIONS
CUSTOMER NAME	:
CUSTOMER REFERENCE NO.	•
MODULE NUMBER	: TSG12864-1185-FFDLWS-R
SAMPLE VERSION	: NO.1
SPECIFICATIONS EDITION	: <u>V0</u>
DRAWING NO. (Ver.)	: A1
PACKAGING NO. (Ver.)	: TBD
Cus	stomer Approved
	Date:

Approved	Checked	Designer
	Aron	Sean

- ☐ Preliminary specification for design input
- Full specification for sample approval

RECORDS OF REVISION

Date YYYY/MM DD	Sample Ver.	Spec. Edi.	Description	CHANGED BY	CHECKED BY
2018.10.31	NO.1	V0	First release	Sean	Aron

Contents:

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 3. INSPECTION SPECIFICATION

4. RELIABILITY TEST

- 4.1 Reliability Test Condition
- 5. PRECAUTION RELATING PRODUCT HANDLING
- **6.PACKING SPECIFICATION**

1. SPECIFICATIONS

1.1 Features

Item	Description
Display Type	128*64 Dots
LCD Type	FSTN /Positive/ Transflective
Driver Condition	1/65 duty, 1/9bais
Viewing Direction	6 O'clock
Backlight Color	White Color
Module weight	About 22.0g
Interface	6800/8080
LCD driver IC	ST7567S-G4
ROHS2.0	YES

1.2 Mechanical Specifications

_			
	Item	Standard Value	Unit
	Outline Dimension	58.20(L) *39.00(w) *8.00 (H) (Exclude the pin)	mm
	Viewing Area	50.00(L) * 25.00(w)	mm
	Active Area	46.05(L) * 23.01(w)	mm
	Dots Size	0.33(L) *0.33(w)	mm
	Dots Pitch	0.36(L) *0.36(W)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	$V_{ m DD}$	_	-0.3	4.0	V
LCD Power Supply Voltage	VLCD,V0	_	-0.3	14	V
Any input/output	$V_{\text{IN}}/V_{\text{OUT}}$	_	-0.3	V _{DD} +0.3	V
Operating Temperature	T_{OP}	_	-20	70	$^{\circ}$ C
Storage Temperature	T_{ST}	_	-40	80	$^{\circ}$ C
Storage Humidity	H_D	Ta < 40 °C	-	90	%RH

1.4 DC Electrical Characteristics

 V_{DD} =3.0 V ±5% , V_{SS} = 0V , Ta = 25°C

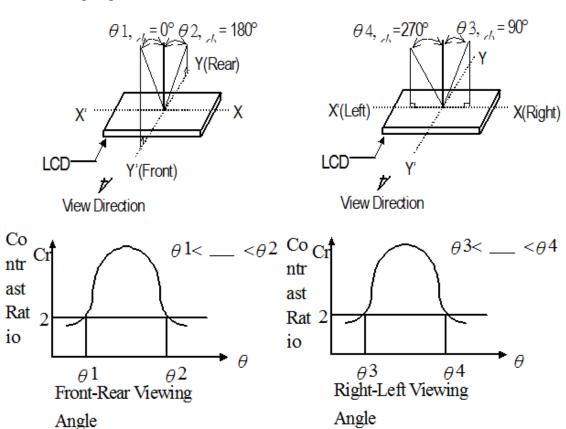
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Operating Voltage	V_{DD}	-	2.85	3.0	3.15	V
Input High-level Voltage	V_{IHC}	-	0.7Vdd	-	Vdd	V
Input Low-level Voltage	$V_{\rm ILC}$	-	V_{SS}	-	0.3Vdd	V
Output High-level Voltage	V_{OHC}	-	$0.8V_{\rm DD}$	-	Vdd	V
Output Low-level Voltage	V _{OLC}	-	V_{SS}	-	0.2Vdd	V
LCD Supply Power	V_{LCD}	-	9.8	10.0	10.2	V
Supply Current	I_{DD}	V _{DD} =3.0V,Vop=10.0V, Pattern= Vertical display	-	0.43	0.65	mA

1.5 Optical Characteristics

LCD Panel: 1/65Duty · 1/9Bias · $V_{OP} = 10.0$ V · Ta = 25°C

			1		, ,			1
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response T	ima	Ton		-	150	250	ma	Note3
Kesponse 1	IIIIE	Toff		-	170	300	ms	Notes
	=0(6H)	Y'	C≥2.0	20	35	-		
Viewing angle	=90(3H)	X		20	35	-	Deg.	Note1
range	=180(12H)	Y		10	25	-		Note1
	=270(9H)	X'		20	35	-		
Contrast Ratio		С	$\theta = 0$ °	4	6	-	-	Note2
Average Brightness (with LCD)		IV	IF=15mA	30	50	-	Cd/m2	Nata
Uniformity(with LCD)		ΔB		70	75	-	%	Note4

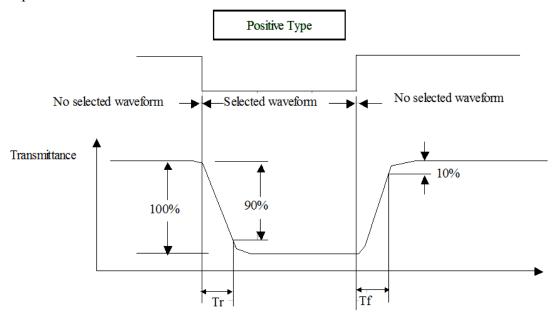
Note 1 Definition of viewing angle

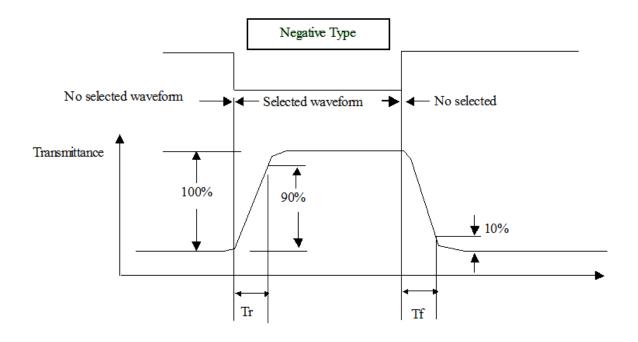


Note 2
Definition of contrast

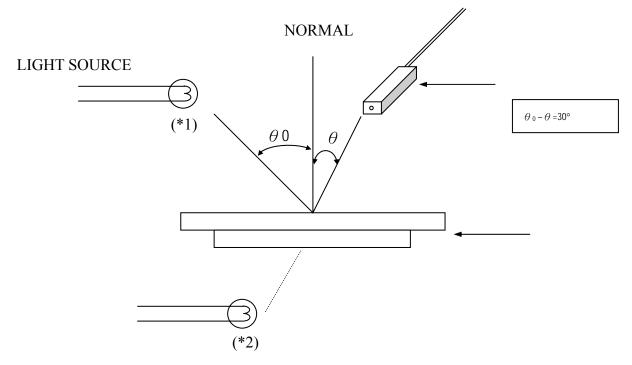
RATIO C.R = Brightness of non-selected segment (B2) Brightness of selected segment Brightness curve of selected segment Brightness curve of selected segment Brightness curve of non-selected segment Operating voltage (Vop)

Note 3 Definition of response time





Note 4
Measuring Instruments For Electro-optical Characteristics



- *1.Light source position for measuring the reflective type of LCD panel
- *2.Light source position for measuring the transflective / transmissive types of LCD panel

1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°C	-	20	mA
Reverse Voltage	VR	Ta =25 ℃	-	5.0	V
Reverse Current	IR	VR= 5V	-	10	uA
Power Dissipation	PD	Ta =25 ℃	-	64	mW

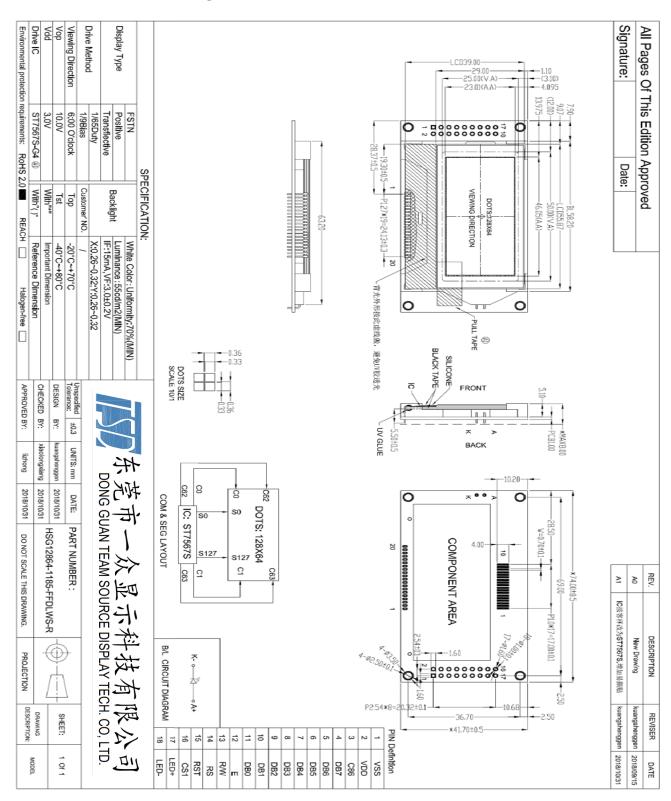
Electrical / Optical Characteristics

Dicertent Option Characteristics								
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit		
Forward Voltage	IF	IF=15mA	2.8	3.0	3.2	V		
Average Brightness (without LCD)	IV	IF=15mA	55	-	-	cd/m ²		
Color Coordinates (Without LCD)	Hue	IF=15mA	X=0.26 Y=0.26	X=0.29 Y=0.29	X=0.32 Y=0.32	nm		
Color			White	•	•			

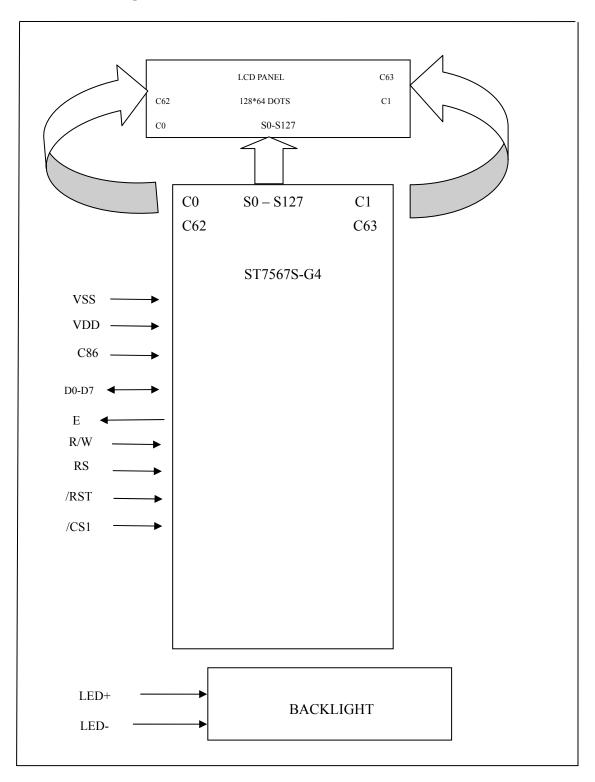
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram



2.1.2 Block Diagram

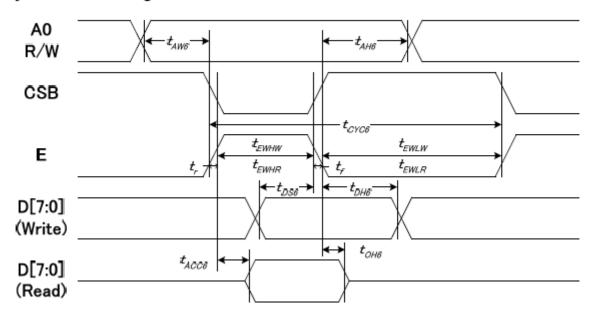


2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	VSS	Power Ground
2	VDD	Main Power supply for the LCM
		This is the MPU interface selection pin.
3	C86	C86 = "H": 6800 Series MPU interface.
		C86 = "L": 8080 Series MPU interface.
4	DB7	
5	DB6	
6	DB5	
7	DB4	9 hit Di direction detabus D[7:0]
8	DB3	8-bit Bi-direction databus D[7:0].
9	DB2	
10	DB1	
11	DB0	
12	RD(E)	Enable clock input for 6800 series MPU
13	RW(R/W)	Read/Write signal for 6800 series MPU.
14	RS	Command/Data selection control pin.H for display data and L for command data
15	/RST	Hardware reset pin. Low active
16	/CS1	Chip selection control pin. Low active
17	LED+	LED anode.
18	LED-	LED cathode

2.3 Timing Characteristics

14-1 System Bus Timing for 6800 Series MPU



(VDD1 = 3.3V, Ta =25°C)

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW6		0		
Address hold time	AU	tAH6		10	_	
System cycle time		tCYC6		240	_]
Enable L pulse width (WRITE)		tEWLW		80	_]
Enable H pulse width (WRITE)	Е	tEWHW		80	_	
Enable L pulse width (READ)		tEWLR		80	_	ns
Enable H pulse width (READ)		tEWHR		140	_	
Write data setup time		tDS6		40	_	
Write data hold time	D[7:0]	tDH6		10	_	
Read data access time	[٥.١]ت	tACC6	CL = 16 pF	_	70	
Read data output disable time		tOH6	CL = 16 pF	5	50	

(VDD1 = 2.8V, Ta =25°C)

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW6		0	1	
Address hold time	AU	tAH6		0	1]
System cycle time		tCYC6		400	_]
Enable L pulse width (WRITE)		tEWLW		220	_	
Enable H pulse width (WRITE)	Е	tEWHW		180	_]
Enable L pulse width (READ)		tEWLR		220	1	ns
Enable H pulse width (READ)		tEWHR		180	-]
Write data setup time		tDS6		40	_]
Write data hold time	D[7:0]	tDH6		20	_]
Read data access time	[ال./ان	tACC6	CL = 16 pF	_	140	
Read data output disable time		tOH6	CL = 16 pF	10	100	

(VDD1 = 1.8V, Ta =25°C)

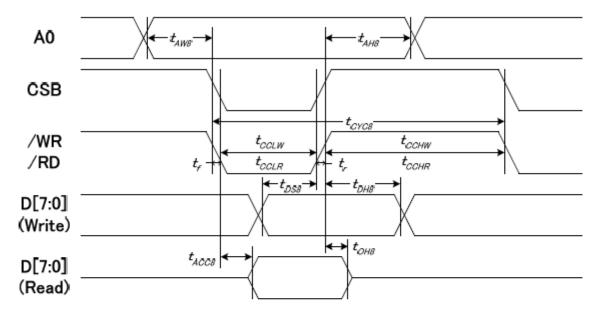
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW6		0	_	
Address hold time	AU	tAH6		0	_]
System cycle time		tCYC6		640	_]
Enable L pulse width (WRITE)]	tEWLW		360	_	1
Enable H pulse width (WRITE)	Е	tEWHW		280	_	1
Enable L pulse width (READ)]	tEWLR		360	_	ns
Enable H pulse width (READ)		tEWHR		280	_]
Write data setup time		tDS6		80	_]
Write data hold time	D(7:01	tDH6		20	_	1
Read data access time	D[7:0]	tACC6	CL = 16 pF	_	240	
Read data output disable time	1	tOH6	CL = 16 pF	10	200	1

^{*1} The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast, (tr + tf) ≤ (tCYC6 - tEWLW - tEWHW) for (tr + tf) ≤ (tCYC6 - tEWLR - tEWHR) are specified.

^{*2} All timing is specified using 20% and 80% of VDD1 as the reference.

^{*3} tEWLW and tEWLR are specified as the overlap between CSB being "L" and E.

14-2 System Bus Timing for 8080 Series MPU



(VDD1 = 3.3V, Ta =25°C)

ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW8		0	_	
Address hold time	ζ.	tAH8		10	_	
System cycle time		tCYC8		240	_	
/WR L pulse width (WRITE)	/WR	tCCLW		80	_	
/WR H pulse width (WRITE)		tCCHW		80	_	
/RD L pulse width (READ)	RD	tCCLR		140	_	ns
/RD H pulse width (READ)	KD.	tCCHR		80	_	
WRITE Data setup time		tDS8		40	_	
WRITE Data hold time	D(7:01	tDH8		20	_	
READ access time	D[7:0]	tACC8	CL = 16 pF	_	70	
READ Output disable time		tOH8	CL = 16 pF	5	50	

(VDD1 = 2.8V, Ta =25°C)

ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW8		0	-	
Address hold time	AU	tAH8		0	_	
System cycle time		tCYC8		400	_	
WR L pulse width (WRITE)	WR	tCCLW		220	_	
/WR H pulse width (WRITE)	[tCCHW		180	_	
/RD L pulse width (READ)	RD	tCCLR		220		ns
/RD H pulse width (READ)	KD	tCCHR		180	_	
WRITE Data setup time		tDS8		40	_	
WRITE Data hold time	D[7:0]	tDH8		20	_	
READ access time		tACC8	CL = 16 pF	_	140	
READ Output disable time		tOH8	CL = 16 pF	10	100	

(VDD1 = 1.8V, Ta =25°C)

ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW8		0	_	
Address hold time	AU	tAH8		0	_]
System cycle time		tCYC8		640	_]
/WR L pulse width (WRITE)	/WR	tCCLW		360	_]
/WR H pulse width (WRITE)		tCCHW		280	_	
/RD L pulse width (READ)	RD	tCCLR		360	_	ns
/RD H pulse width (READ)	KD	tCCHR		280		
WRITE Data setup time		tDS8		80	_]
WRITE Data hold time	D[7:0]	tDH8		20	_	1
READ access time	D[7.0]	tACC8	CL = 16 pF	_	240	
READ Output disable time		tOH8	CL = 16 pF	10	200	

^{*1} The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast, (tr + tf) ≤ (tCYC8 - tCCLW - tCCHW) for (tr + tf) ≤ (tCYC8 - tCCLR - tCCHR) are specified.

^{*2} All timing is specified using 20% and 80% of VDD1 as the reference.

^{*3} tCCLW and tCCLR are specified as the overlap between CSB being "L" and WR and RD being at the "L" level.

3. Inspection Specification

AQL inspection standard

Sampling method: GB/T2828.1-2012, Level II, single sampling

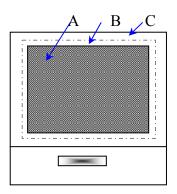
Defect classification:

Classify	Item	Note	AQL	
	Short or open circuit			
	LC Leakage			
Maian	Display flickering	1	0.65	
Major	No display	1	0.03	
	Wrong viewing direction			
	Wrong Back-light color			
	Contrast defect(dim,ghost)	2		
	Background color deviation	2		
	black & white spot, dust	3		
	Black, white line defect	4	1.0	
Minor	Rainbow	5	1.0	
	Chip	6		
	Pin hole	7		
	Cross talk	Refer to sample		

Definition:

Zone A: Active Area Zone B: Visible Area

Zone C: outside of Visible Area



No.	Item	Criterion					
	Short or open circuit						
	LC leakage						
	Flickering						
1	No display	Not allowed					
1	Wrong viewing	Not allowed					
	direction						
	Wrong Back-light						
	color						
	Contrast defect						
2	Background color	Refer to approval sar	mple				
	deviation						
3	black & white spot, dust(including polarizer). $\phi=(X+Y)/2$	Unit:mm	A	Accept QTY A B Any 2 3 0 1			
				α:		. 11	
			T	Size		eptable (
		. → 1	L	W	A	В	С
4	Black, white line	L W	Any	W≤0.01 0.01 <w≤0.02< td=""><td>Any 2</td><td>Any 4</td><td>A</td></w≤0.02<>	Any 2	Any 4	A
4	defect	1	L≤2	$0.01 < W \le 0.02$ $0.02 < W \le 0.03$	1	2	An
			L <u>></u> 4	$0.02 < W \le 0.03$ $0.03 < W$	0	0	У
		Unit:mm		0 03 ~ ٧٧	U	1 0	
		Remark: While W>0	.03.ref	er to point defect			
5	Rainbow	Not more than two c	•	-	viewing	g area	

Chip

Remark:

T: glass thickness

X: Notch in X directionY: Notch in Y directionZ: Notch in Z direction

OAN TEAM C	OUNC		_						, .
A type and B type:	General								
X	X			X		¥.	//	/	
X	Y		Z						
1 Any	≤2.0		<u>≤</u>]	1/2t					
2 direction glass length	Can not read the Visible a	ch rea	≤t						
C Type :ITO termin	al		Г		X		Y		Z
			f		Any	,	≤0. 3	3	<u>-</u> ≤1/2t
No.	X		-	≤1/8X	dir	ection	≤1/5	t	≤t
D Type :Corner 1 (on ladga)								
D Type :Comer I (on leage)		ſ	X			Y		Z
	Y			≤2		≤ (Can n	1.5	each	≤t
						ITO to			
E Type:Corner 2 (be	eside seal)					<u>I</u>			
X Y				X		Y	A	Accep Q1	table Y
z			≤(3. 0		Can not	1	Ar	ıy
F Type :Back of the	ITO term	inal					•		
У	x	Х		Y		Z			ptable TY
Z		≤3.	0	≤1. (0	Z≤1/2	t	A	ny
G Tyep:Crack		ı							
	>/								

Can not accept any crack at

anywhere

No.	Item	Criterion					
7	Pin hole	D=(X+Y)/2 X:pin hole length Y:pin hole width d:pattern(segments,dot) width	D D≤1/5d and D≤0.15 D≤1/5d and 0.15 <d<0.2 d="">1/5d or D≥0.2</d<0.2>	Acceptable QTY Any 1 0			
8	Total number of acceptable defect	A area(active area) Maximum 2 minor non-conformities per one unit. Defect distance: should be over 10 mm between each point B area(Visible area) It is acceptable when it is no trouble for quality and assembly in customer's end product					

4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage	Keep in 80±2℃ 96 hrs
1	Test	Surrounding temperature, then storage at normal condition 4hrs
2	Low Temperature Storage	Keep in -40±2°C 96 hrs
2	Test	Surrounding temperature, then storage at normal condition 4hrs
	High Temperature	Endurance test of electrical stress (Voltage & Current) and
3	Operation	the thermal stress to the elemen
	operation	Keep in 70°C±2°C 96 hrs
	Low Temperature	Endurance test of electrical stress (Voltage & Current) and
4	Operation	the thermal stress to the element.
	o p a a marca	Keep in -20±2℃ 96 hrs
		Keep in +40 ℃/90%RH duration for 96 hrs
5	High Humidity Storage	Surrounding temperature, then storage at normal condition 4hrs(excluding
		the polarizer)

		$-40^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 80^{\circ}\text{C} \rightarrow 25^{\circ}\text{C}$			
6	6 Thermal shock	(1Hrs) (5mins) (1Hrs) (5mins)			
	Thermal shock	10 Cycle			
		Surrounding temperature, then storage at normal condition 4hrs			
_		1. Sine wave $10 \sim 50$ HZ frequency (1 min)			
7	Vibration Test (Packaged)	2. The amplitude of vibration :1.5 mm			
		3. Each direction (XYZ) duration for 2 Hrs			

5. PRECAUTION RELATING PRODUCT HANDLING

The following precautions should be followed, since this module contains precise parts.

- (1) Do not store module for an extended periods of time under the conditions of high temperature and high humidity.
- (2) Avoid using or storing the module in areas that expose it to direct sunlight or ultraviolet rays.
- (3) Use protective finger covers when handling the module to avoid scratching or staining the module.
- (4) Care should be taken not to expose the module to static electricity, because the module contains C-MOS LSI's.
 - (5) The LSI is sensitive to light.

 The user's product should be designed so that LSI is not exposed to any light during operation.
- (6) During installation, cover the display area with acrylic protection plates to protect the polarizer plate and LCD cells.
- (7) Do not apply any excessive shocks to the module because the module contains sensitive LCD cells.

Do not use a module, which has experienced strong mechanical shock.

- (8) Care should be taken when the power supply turns on as following.
 - (a) Do not apply any input signals before the supplying voltage is applied.
 - (b) Do not turn off the power supply while any input signals are applied.

Caution

- (1) Dangerous. Do not shock glass because glass can break.
- (2) If module breaks, do not touch it directly.

(Glass could stick or cut skin.)

(3) Do not swallow Liquid Crystal.

(In case of broken LCD panel, do not swallow liquid crystal even if there is no proof that

liquid crystal is poisonous.)

- (4) If liquid crystal is exposed to skin, wash the area thoroughly with alcohol or soap.
- (5) When disposing of the product, please observe industrial waste disposal laws in each country and district.
- (6) In case of injury, give immediate treatment and consult with a doctor.
- (7) This product is constructed precisely. Don't disassemble or modify.
- * Neglecting this mark can cause injury to humans and damage to materials

6.0 PACKING SPECIFICATION

TBD